

# **Description**

The FMXA-4203S is a fast recovery diode of 300 V / 20 A. The maximum  $t_{\rm rr}$  of 25 ns is realized by optimizing a life-time control.

#### **Features**

<ul> <li>V<sub>RM</sub>-</li> </ul>					 	 - 300 V
<ul> <li>I<sub>F(AV)</sub></li> </ul>					 	 20 A
<ul> <li>V<sub>F</sub></li> </ul>					 	 -1.30 V
• t <sub>rr</sub>					 	 25 ns
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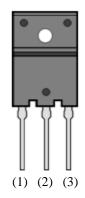
- Bare lead frame: Pb-free (RoHS compliant)
- Flammability: Equivalent to UL94V-0

# **Applications**

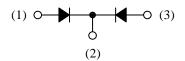
- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

## **Package**

TO3PF-3L



Not to scale



- (1) Anode
- (2) Cathode
- (3) Anode

## **FMXA-4203S**

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RSM}$		300	V
Repetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RM}$		300	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	20	Α
Surge Forward Current <sup>(1)</sup>	I <sub>FSM</sub>	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I <sup>2</sup> t Limiting Value <sup>(1)</sup>	$I^2t$	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	$A^2s$
Junction Temperature	$T_{J}$		-40 to 150	°C
Storage Temperature	$T_{STG}$		-40 to 150	°C

#### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drog(1)	$V_{\mathrm{F}}$	$T_J = 25  ^{\circ}\text{C}, I_F = 10  \text{A}$	_	_	1.30	V
Forward Voltage Drop <sup>(1)</sup>		$T_J = 100  ^{\circ}\text{C},  I_F = 10  \text{A}$	_	1.03	_	V
Reverse Leakage Current <sup>(1)</sup>	$I_R$	$V_R = V_{RM}$	_	_	100	μΑ
Reverse Leakage Current under High Temperature <sup>(1)</sup>	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150  ^{\circ}C$	_	_	30	mA
Reverse Recovery Time <sup>(1)</sup>	t <sub>rr</sub>	$I_F = I_{RP} = 500 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$			25	ns
Thermal Resistance <sup>(2)</sup>	R <sub>th(J-C)</sub>		_	_	2.0	°C/W

## **Mechanical Characteristics**

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.686		0.882	N·m

 $<sup>^{\</sup>left(1\right)}$  Specifies a value per chip; the FMXA-4203S consists of two chips.

 $<sup>^{(2)}</sup>R_{th (J-C)}$  is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

## **Rating and Characteristic Curves**

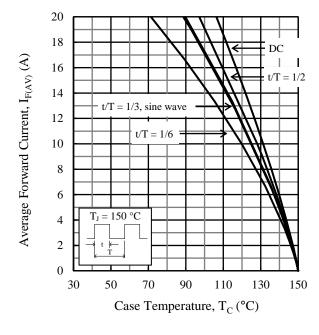


Figure 1. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_{C}$   $(V_{R}=0\ V)$ 

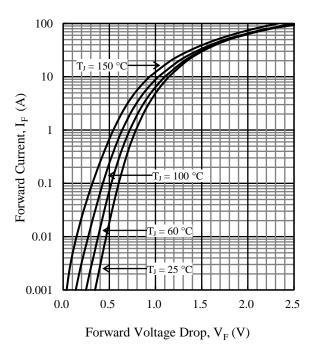


Figure 3. Typical Characteristics: I<sub>F</sub> vs. V<sub>F</sub>

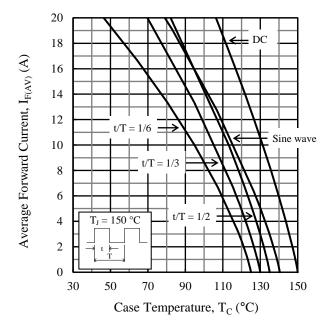


Figure 2. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_{C}$  ( $V_{R} = 300 \ V$ )

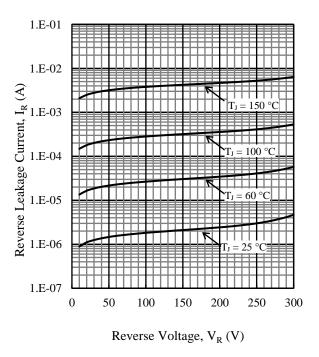
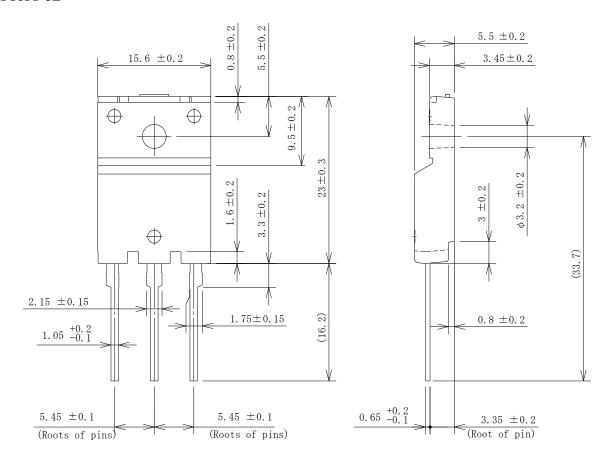
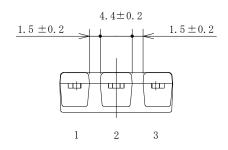


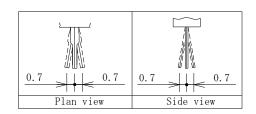
Figure 4. Typical Characteristics: I<sub>R</sub> vs. V<sub>R</sub>

# **Physical Dimensions**

#### • TO3PF-3L







#### **NOTES:**

- Dimensions in millimeters.
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times

Soldering Iron: 380  $\pm$  10  $^{\circ}C$  / 3.5  $\pm$  0.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

## **Marking Diagram**

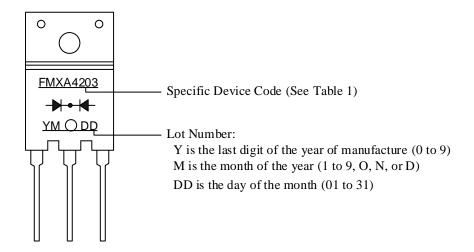


Table 1. Specific Device Code

Specific Device Code	Part Number
FMXA4203	FMXA-4203S

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